

Electronic Patent Application Fee Transmittal

Application Number:	10776203			
Filing Date:	12-Feb-2004			
Title of Invention:	METHOD & APPARATUS FOR MULTI-STAGE SPUTTER DEPOSITION OF UNIFORM THICKNESS LAYERS			
First Named Inventor/Applicant Name:	Rajiv Yadav Ranjan			
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Attorney Docket Number:	SEAG-STL-3394			
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